

DATA SHEET

SKY77589-21 Tx-Rx Quad-Band Front-End Module for GSM / GPRS (824-915 MHz) (1710-1910 MHz) w/ Six Linear TRx Switch Ports

Applications

- Quad-band cellular handsets encompassing
 - Class 4 GSM850 / GSM900
 - DCS1800 / PCS1900
 - Class 12 GPRS multi-slot operation
 - EDGE downlink compatible

Features

- High efficiency
 - 42% (GSM850)
 - 45% (GSM900)
 - 39% (DCS1800 / PCS1900)
- Low transmit supply current
 - 1.35 A (GSM850)
 - 1.26 A (GSM900)
 - 0.92 A (DCS1800 / PCS1900)
- 50 Ω matched Input/Output
- Tx-VCO-to-antenna and antenna-to-Rx-SAW filter RF interface
- RF switch affords high linearity, low insertion loss, and 0 V DC on Rx ports
- Small, low profile package
 - 6 mm x 6 mm x 0.9 mm
 - 28-pad configuration



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to Skyworks Definition of Green™, document number SQ04-0074.

Description

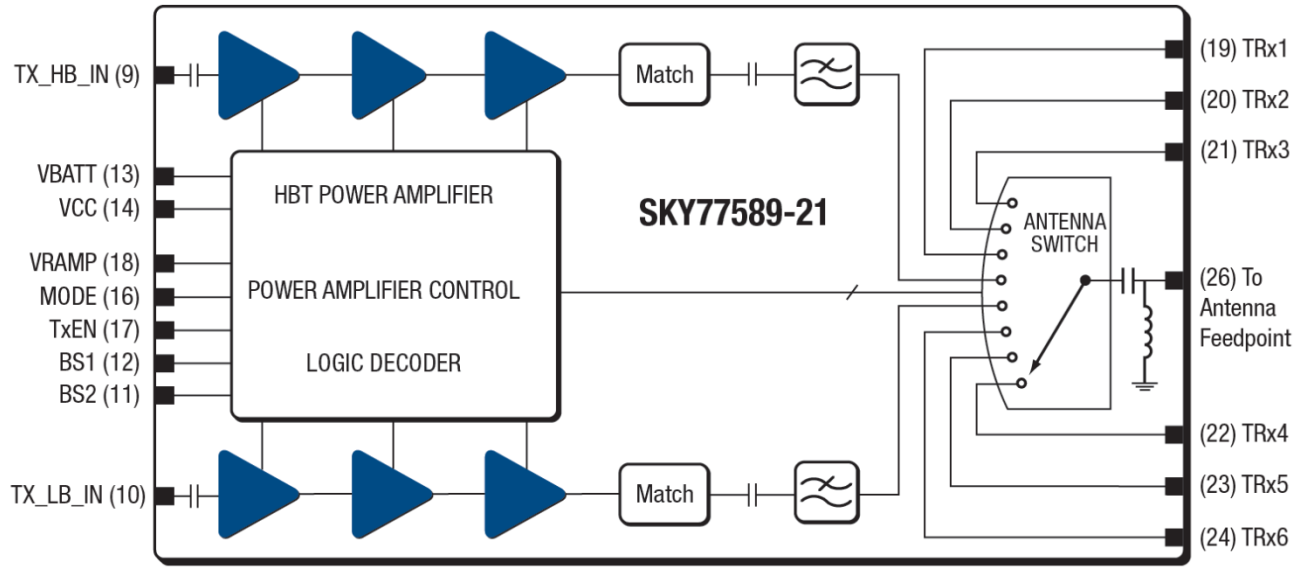
SKY77589-21 is a transmit and receive Front-End Module (FEM) with integrated power amplifier control designed in a low profile, compact form factor for quad-band cellular handsets comprising GSM850 / GSM900 and DCS1800 / PCS1900 operation. The SKY77589-21 offers a complete Transmit VCO-to-Antenna and Antenna-to-Receive SAW filter solution. The FEM also supports Class 12 General Packet Radio Service (GPRS) multi-slot operation and EDGE downlink.

The module consists of a GSM850 / GSM900 PA block and a DCS1800 / PCS1900 PA block, impedance-matching circuitry for 50 ohm input and output impedances, Tx harmonics filtering, high linearity / low insertion loss RF switch, and a Power Amplifier Control (PAC) block. One PA block supports the GSM850 / GSM900 bands and the other PA block supports the DCS1800 / PCS1900 bands. Both PA blocks share common power supply pads to distribute current. The output of each PA block and the outputs to the six receive pads are connected to the antenna pad through an RF switch. Six broadband interchangeable receive ports provide flexibility to support multimode and multiband configurations. The GaAs die, the CMOS die, the Switch die, and passive components are mounted on a multi-layer laminate substrate. The assembly is encapsulated with plastic overmold.

Band selection and control of transmit and receive are performed using four external control pads. Refer to the block diagram in Figure 1 below. The band select pad, BS1, BS2, Mode, and TxEN select GSM850, GSM900, DCS, and PCS modes of operation.

Transmit enable TxEN controls receive or transmit mode of the RF switch (Tx = logic 1). Proper timing between transmit enable TxEN and Analog Power Control VRAMP allows for high isolation between the antenna and Tx-VCO while the VCO is being tuned prior to the transmit burst.

The SKY77589-21 is compatible with logic levels from 1.2 V to 2.9 V for BS1, BS2, MODE, and TxEN pads.



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Figure 1. SKY77589-21 Functional Block Diagram

Electrical Specifications

The following tables list the electrical characteristics of the SKY77589-21 Front-End Module. The absolute maximum ratings and recommended operating conditions for the SKY77589-21 are listed in Table 1 and Table 2, respectively. Table 3 specifies the mode control logic and Tables 4 through 9 contain the electrical characteristics of the SKY77589-21 for modes GSM850 /

GSM900 and DCS1800 / PCS1900. Figure 2 presents an application schematic for the SKY77589-21.

The SKY77589-21 is a static-sensitive electronic device and should not be stored or operated near strong electrostatic fields. Detailed information on device dimensions, pad descriptions, packaging and handling can be found in later sections of this data sheet.

Table 1. SKY77589-21 Absolute Maximum Ratings

No damage assuming only one parameter is set at limit with all other parameters set at nominal value.

| Parameter | Minimum | Nominal | Maximum | Unit |
|--------------------------------------|------------------------|---------|-------------------|------|
| Input Power (P _{IN}) | — | — | 15 | dBm |
| Supply Voltage (V _{CC}), | Standby ¹ | — | 6 | V |
| | BS1, BS2, MODE, TxEN | — | V _{BATT} | |
| Control Voltage (V _{RAMP}) | -0.5 | — | V _{BATT} | V |
| Temperature | Operating ² | -40 | +85 | °C |
| | Storage | -55 | +25 | |

¹ Standby [Supply voltage < 1 μs (measurement to ground)]

² Ambient temperature.

Table 2. SKY77589-21 Recommended Operating Conditions

| Parameter | | Minimum | Nominal | Maximum | Unit |
|--|--|---------|---------|---------|------|
| Supply Voltage – GMSK ¹ | V _{BATT} | 3.1 | 3.5 | 4.3 | V |
| | V _{CC} | 2.5 | 3.5 | 4.3 | |
| Operating Case Temperature (T _{CASE}) ² | 1-Slot (12.5% duty cycle) | -20 | — | +85 | °C |
| | 2-Slot (25% duty cycle) | -20 | — | +85 | |
| | 3-Slot (37.5% duty cycle) ³ | -20 | — | +85 | |
| | 4-Slot (50% duty cycle) ³ | -20 | — | +85 | |

¹ V_{BATT} and V_{CC} should be common unless DC/DC is used and V_{CC} can be separately supplied.

² Case Operating Temperature refers to the temperature of the GROUND PAD on the underside of the package.

³ Maximum output power must be reduced by 6 dB to support 3-slot and 4-slot operation.

Table 3. SKY77589-21 Mode Control Logic

| Mode | Input Control Bits | | | |
|------------|--------------------|------|-----|-----|
| | TxEN | MODE | BS1 | BS2 |
| Standby | 0 | 0 | 0 | 0 |
| LB_GMSK_Tx | 1 | 0 | 0 | 1 |
| HB_GMSK_Tx | 1 | 0 | 1 | 1 |
| TRx1 | 0 | 1 | 0 | 0 |
| TRx2 | 0 | 1 | 1 | 0 |
| TRx3 | 0 | 1 | 0 | 1 |
| TRx4 | 0 | 1 | 1 | 1 |
| TRx5 | 0 | 0 | 1 | 0 |
| TRx6 | 0 | 0 | 0 | 1 |

Table 4. SKY77589-21 Electrical Specifications

Unless otherwise specified: T_{case} = -20 °C to max. Operating temperature (see Table 2); R_L = 50 Ω; pulsed operation with pulse width ≤ 1154 μs; duty cycle ≤ 2:8; 3.1 V ≤ V_{cc} ≤ 4.3 V

| General | | | | | | | |
|-------------------------|--------------------|------------------------|---|---------|---------|------|----|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Unit | |
| Supply Voltage | V _{BATT} | — | 3.1 | 3.5 | 4.3 | V | |
| | V _{CC} | — | 2.5 | 3.5 | 4.3 | | |
| Power Control Impedance | Z _{VRAMP} | — | 5 | — | — | MΩ | |
| BS1 Control Voltage | LOW | V _{BS1_LOW} | -0.1 | — | 0.3 | V | |
| | HIGH | V _{BS1_HIGH} | 1.2 | — | Note 1 | | |
| BS1 Current | I _{BS1} | — | — | — | 36 | μA | |
| BS2 Control Voltage | LOW | V _{BS2_LOW} | -0.1 | — | 0.3 | V | |
| | HIGH | V _{BS2_HIGH} | 1.2 | — | Note 1 | | |
| BS2 Current | I _{BS2} | — | — | — | 36 | μA | |
| MODE Control Voltage | LOW | V _{MODE_LOW} | -0.1 | — | 0.3 | V | |
| | HIGH | V _{MODE_HIGH} | 1.2 | — | Note 1 | | |
| MODE Select Current | I _{MODE} | — | — | — | 36 | μA | |
| TxEN Control Voltage | LOW | V _{TxEN_LOW} | -0.1 | — | 0.3 | V | |
| | HIGH | V _{TxEN_HIGH} | 1.2 | — | Note 1 | | |
| TxEN Control Current | I _{TxEN} | — | — | — | 36 | μA | |
| Leakage Current | Standby Mode | I _{qs} | 3.1 V ≤ V _{BATT} ≤ 4.3 V BS1 = V _{BS1_LOW} V _{RAMP} ≤ 0.1 V TxEN ≤ TxEN _{LOW} BS2 ≤ V _{BS2_LOW} MODE < V _{MODE_LOW} T _{CASE} = +25 °C P _{IN} ≤ -60 dBm | — | 10 | 25 | μA |
| | WCDMA Mode | I _{qMODE} | 3.1 V ≤ V _{BATT} ≤ 4.3 V V _{RAMP} ≤ 0.1 V TxEN ≤ TxEN _{LOW} T _{CASE} = +25 °C P _{IN} ≤ -60 dBm | — | 70 | 120 | |

¹ Apply the lesser of 2.9 V or V_{CC}.

Table 5-1. SKY77589-21 Electrical Specifications

Unless otherwise specified: $T_{CASE} = -20\text{ }^{\circ}\text{C}$ to max. Operating temperature (see Table 2); $RL = 50\ \Omega$; pulsed operation with pulse width $\leq 1154\ \mu\text{s}$; duty cycle $\leq 2:8$; $3.1\ \text{V} \leq V_{CC} \leq 4.3\ \text{V}$

| GSM850 (Tx_LB) Mode ($f = 824\ \text{MHz}$ to $849\ \text{MHz}$; $0\ \text{dBm} \leq P_{IN} \leq 6\ \text{dBm}$) | | | | | | |
|---|----------------------------|--|---------|---------|---------|------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Unit |
| Frequency Range | f | — | 824 | — | 849 | MHz |
| Input Power | P_{IN} | — | 0 | — | 6 | dBm |
| Analog Power Control Voltage | V_{RAMP} | Minimum PCL to PRATED | — | — | 1.6 | V |
| Power Added Efficiency | PAE | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 33\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 42 | — | % |
| Supply Current at Rated Power | $I_{BATT_33\ \text{dBm}}$ | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 33\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 1.35 | — | A |
| Harmonics | $2f_0$ to $13f_0$ | $BW = 3\ \text{MHz}$ $5\ \text{dBm} \leq P_{OUT} \leq 33\ \text{dBm}$ V_{RAMP} controlled ¹ | — | -40 | -33 | dBm |
| Output Power | P_{OUT_MAX} | $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | — | 34.4 | — | dBm |
| | $P_{OUT_MAX_EXTREME}$ | $V_{BATT} = 3.1\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | 31.0 | — | — | |
| Input VSWR | Γ_{IN} | $5\ \text{dBm} \leq P_{OUT} \leq 33\ \text{dBm}$ V_{RAMP} controlled ¹ | — | 1.5:1 | 2.5:1 | |
| Forward Isolation ² | P_{OUT_RX} | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_LOW}$ $BS2 = V_{BS2_LOW}$ $TxEN = V_{TxEN_LOW}$ | — | -58 | -42 | dBm |
| | $P_{OUT_ENABLED_TX}$ | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_LOW}$ $BS2 = V_{BS2_HIGH}$ $TxEN = V_{TxEN_HIGH}$ | — | -40 | -15 | |

Table 5-2. SKY77589-21 Electrical Specifications

Unless otherwise specified: T_{CASE} = -20 °C to max. operating temperature (see Table 2); RL = 50 Ω; pulsed operation with pulse width ≤ 1154 μs; duty cycle ≤ 2:8; 3.1 V ≤ V_{CC} ≤ 4.3 V

| GSM850 (Tx_LB) Mode (f = 824 MHz to 849 MHz, 0 dBm ≤ P _{IN} ≤ 6 dBm) | | | | | | |
|---|----------------|--|---|---------|---------|------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Unit |
| Coupling of GSM850/900 Tx Output (f ₀) to Rx Output pad ² | CGHI_Tx-Rx_f0 | V _{BATT} + 3.5 V, 5 dBm ≤ P _{OUT} ≤ 33 dBm | — | — | 0 | dBm |
| Coupling of GSM850/900 Tx Output (2f ₀ , 3f ₀) to Rx Output pad ² | CGHI_Tx-DCS_Rx | V _{BATT} + 3.5 V, 5 dBm ≤ P _{OUT} ≤ 33 dBm | — | — | -32 | dBm |
| Spurious | Spur | All combinations of the following parameters: V _{RAMP} = controlled ¹ P _{IN} = min. to max. 3.1 V ≤ V _{BATT} ≤ 4.3 V -20 °C ≤ T _{CASE} ≤ +85 °C Load VSWR = 12:1, all phase angles | No parasitic oscillation > -36 dBm | | | |
| Load Mismatch | Load | All combinations of the following parameters: V _{RAMP} = controlled ¹ P _{IN} = min. to max. 3.1 V ≤ V _{BATT} ≤ 4.3 V -20 °C ≤ T _{CASE} ≤ +85 °C Load VSWR = 20:1, all phase angles | No module damage or permanent degradation | | | |
| Rx Band Noise | RX_NOISE | At f ₀ + 20 MHz (869 MHz to 894 MHz) RBW = 100 kHz V _{BATT} = 3.5 V T _{CASE} = +25 °C P _{OUT} = 33 dBm | — | -85 | -83 | dBm |
| | | At 1930 MHz to 1990 MHz RBW = 100 kHz V _{BATT} = 3.5 V T _{CASE} = +25 °C P _{OUT} = 33 dBm | — | — | -84 | |
| Power Control Dynamic Range | PCDR | — | 30 | — | — | dB |
| Power Control Slope | PCS | V _{BATT} = 3.5 V P _{IN} = 3 dBm P _{OUT} = 5 dBm T _{CASE} = +25 °C | — | 65 | — | dB/V |

¹ V_{RAMP} is calibrated to each PCL at T_{CASE} = +25 °C, V_{BATT} = 3.5 V, P_{IN} = 3 dBm, 50 Ω load.

² Terminate all unused RF ports with 50 Ω loads

Table 6-1. SKY77589-21 Electrical Specifications

Unless otherwise specified: $T_{CASE} = -20\text{ }^{\circ}\text{C}$ to max. operating temperature (see Table 2); $RL = 50\ \Omega$; pulsed operation with pulse width $\leq 1154\ \mu\text{s}$; duty cycle $\leq 2:8$; $3.1\ \text{V} \leq V_{CC} \leq 4.3\ \text{V}$

| GSM900 (Tx_LB) Mode ($f = 880\ \text{MHz}$ to $915\ \text{MHz}$, $0\ \text{dBm} \leq P_{IN} \leq 6\ \text{dBm}$) | | | | | | |
|---|----------------------------|--|---------|---------|---------|-------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Units |
| Frequency Range | f | — | 880 | — | 915 | MHz |
| Input Power | P_{IN} | — | 0 | — | 6 | dBm |
| Analog Power Control Voltage | V_{RAMP} | Minimum PCL to P_{RATED} | — | — | 1.6 | V |
| Power Added Efficiency | PAE | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 33\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 45 | — | % |
| Supply Current at Rated Power | $I_{BATT_33\ \text{dBm}}$ | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 33\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 1.26 | — | A |
| Harmonics | $2f_0$ to $13f_0$ | $BW = 3\ \text{MHz}$ $5\ \text{dBm} \leq P_{OUT} \leq 33\ \text{dBm}$ V_{RAMP} controlled ¹ | — | -40 | -33 | dBm |
| Output Power | P_{OUT_MAX} | $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | — | 34.3 | — | dBm |
| | $P_{OUT_MAX_EXTREME}$ | $V_{BATT} = 3.1\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | 31.00 | — | — | |
| Input VSWR | Γ_{IN} | $P_{OUT} = 5\ \text{dBm}$ to $33\ \text{dBm}$ V_{RAMP} controlled ¹ | — | 1.5:1 | 2.5:1 | |
| Forward Isolation ² | P_{OUT_RX} | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_LOW}$ $BS2 = V_{BS2_LOW}$ $TxEN = V_{TxEN_LOW}$ | — | -58 | -42 | dBm |
| | $P_{OUT_ENABLED_TX}$ | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_LOW}$ $BS2 = V_{BS2_HIGH}$ $TxEN = V_{TxEN_HIGH}$ | — | -40 | -15 | |

Table 6-2. SKY77589-21 Electrical Specifications

Unless otherwise specified: T_{CASE} = -20 °C to max. operating temperature (see Table 2); RL = 50 Ω; pulsed operation with pulse width ≤ 1154 μs; duty cycle ≤ 2:8; 3.1 V ≤ V_{CC} ≤ 4.3 V

| GSM900 (Tx_LB) Mode (f = 880 MHz to 915 MHz, 0 dBm ≤ P _{IN} ≤ 6 dBm) | | | | | | |
|---|---------------|--|---|---------|---------|-------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Units |
| Coupling of GSM850/900 Tx Output (f ₀) to Rx Output pad ² | CGHI_Tx-Rx_f0 | V _{BATT} + 3.5 V, 5 dBm ≤ P _{OUT} ≤ 33 dBm | — | — | 0 | dBm |
| Coupling of GSM850/900 Tx Output (2f ₀ , 3f ₀) to Rx Output pad ² | CGHI_Tx_Rx | V _{BATT} + 3.5 V, 5 dBm ≤ P _{OUT} ≤ 33 dBm | — | — | -32 | dBm |
| Spurious | Spur | All combinations of the following parameters: V _{RAMP} = controlled ¹ P _{IN} = min. to max. 3.1 V ≤ V _{BATT} ≤ 4.3 V -20 °C ≤ T _{CASE} ≤ +85 °C Load VSWR = 12:1, all phase angles | No parasitic oscillation > -36 dBm | | | |
| Load Mismatch | Load | All combinations of the following parameters: V _{RAMP} = controlled ¹ P _{IN} = min. to max. 3.1 V ≤ V _{BATT} ≤ 4.3 V -20 °C ≤ T _{CASE} ≤ +85 °C Load VSWR = 20:1, all phase angles | No module damage or permanent degradation | | | |
| Rx Band Noise | RX_NOISE | At f ₀ + 20 MHz (935 MHz to 960 MHz) RBW = 100 kHz V _{BATT} = 3.5 V T _{CASE} = +25 °C P _{OUT} = 33 dBm | — | -85 | -83 | dBm |
| | | At f ₀ + 10 MHz (925 MHz to 935 MHz) RBW = 100 kHz V _{BATT} = 3.5 V T _{CASE} = +25 °C P _{OUT} = 33 dBm | — | — | -76 | |
| | | At 1805 MHz to 1880 MHz RBW = 100 kHz V _{BATT} = 3.5 V T _{CASE} = +25 °C P _{OUT} = 33 dBm | — | -101 | -84 | |
| Power Control Dynamic Range | PCDR | — | 30 | — | — | dB |
| Power Control Slope | PCs | V _{BATT} = 3.5 V P _{IN} = 3 dBm P _{OUT} = 5 dBm T _{CASE} = +25 °C | — | 65 | — | dB/V |

¹ V_{RAMP} is calibrated to each PCL at T_{CASE} = +25 °C, V_{BATT} = 3.5 V, P_{IN} = 3 dBm, 50 Ω load.

² Terminate all unused RF ports with 50 Ω loads

Table 7-1. SKY77589-21 Electrical Specifications

Unless otherwise specified: $T_{CASE} = -20\text{ }^{\circ}\text{C}$ to max. operating temperature (see Table 2); $R_L = 50\ \Omega$; pulsed operation with pulse width $\leq 1154\ \mu\text{s}$ and duty cycle $\leq 2:8$; $3.1\ \text{V} \leq V_{CC} \leq 4.3\ \text{V}$

| DCS1800 (Tx_HB) Mode ($f = 1710\ \text{MHz}$ to $1785\ \text{MHz}$, $0\ \text{dBm} \leq P_{IN} \leq 6\ \text{dBm}$) | | | | | | |
|--|----------------------------|--|---------|---------|---------|-------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Units |
| Frequency Range | f | — | 1710 | — | 1785 | MHz |
| Input Power | P_{IN} | — | 0 | — | 6 | dBm |
| Analog Power Control Voltage | V_{RAMP} | Minimum PCL to PRATED | — | — | 1.6 | V |
| Power Added Efficiency | PAE | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 31\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 39 | — | % |
| Supply Current at Rated Power | $I_{BATT_31\ \text{dBm}}$ | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 31\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 0.92 | — | A |
| Harmonics | $2f_0$ to $7f_0$ | $BW = 3\ \text{MHz}$, $0\ \text{dBm} \leq P_{OUT} \leq 31\ \text{dBm}$ V_{RAMP} controlled ¹ | — | -40 | -33 | dBm |
| Output Power | P_{OUT_MAX} | $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | — | 32.0 | — | dBm |
| | $P_{OUT_MAX_EXTREME}$ | $V_{BATT} = 3.1\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | 29.0 | — | — | |
| Input VSWR | Γ_{IN} | $0\ \text{dBm} \leq P_{OUT} \leq 31\ \text{dBm}$ V_{RAMP} controlled ¹ | — | 1.5:1 | 2.5:1 | — |
| Forward Isolation ² | $P_{OUT\ \text{RX}}$ | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_LOW}$ $BS2 = V_{BS2_LOW}$ $TxEN = V_{TxEN_LOW}$ | — | -60 | -51 | dBm |
| | $P_{OUT_ENABLED_TX}$ | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_HIGH}$ $BS2 = V_{BS2_HIGH}$ $TxEN = V_{TxEN_HIGH}$ | — | -40 | -15 | |

Table 7-2. SKY77589-21 Electrical Specifications

Unless otherwise specified: $T_{CASE} = -20\text{ }^{\circ}\text{C}$ to max. operating temperature (see Table 2); $R_L = 50\ \Omega$; pulsed operation with pulse width $\leq 1154\ \mu\text{s}$; duty cycle $\leq 2:8$; $3.1\ \text{V} \leq V_{CC} \leq 4.3\ \text{V}$

| DCS1800 (Tx_HB) Mode ($f = 1710\ \text{MHz}$ to $1785\ \text{MHz}$, $0\ \text{dBm} \leq P_{IN} \leq 6\ \text{dBm}$) | | | | | | |
|--|---------------|---|--|---------|---------|-------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Units |
| Coupling of DCS Tx output to Receive RF output pad ² | CDCS_Tx-Rx_fo | $0\ \text{dBm} \leq P_{OUT} \leq 31\ \text{dBm}$ | — | — | 5 | dBm |
| Spurious | Spur | All combinations of the following parameters: $V_{RAMP} = \text{controlled}^1$ $P_{IN} = \text{min. to max.}$ $3.1\ \text{V} \leq V_{BATT} \leq 4.3\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ Load VSWR = 12:1, all phase angles | No parasitic oscillation $> -36\ \text{dBm}$ | | | |
| Load Mismatch | Load | All combinations of the following parameters: $V_{RAMP} = \text{controlled}^1$ $P_{IN} = \text{min. to max.}$ $3.1\ \text{V} \leq V_{BATT} \leq 4.3\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ Load VSWR = 20:1, all phase angles | No module damage or permanent degradation | | | |
| Rx Band Noise | RX_NOISE | At $f_0 + 20\ \text{MHz}$ (1805 MHz to 1880 MHz) RBW = 100 kHz $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{OUT} = 31\ \text{dBm}$ | — | — | -83 | dBm |
| | | 925 MHz to 960 MHz RBW = 100 kHz $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{OUT} = 31\ \text{dBm}$ | — | — | -87 | |
| Power Control Dynamic Range | PCDR | — | 35 | — | — | dB |
| Power Control Slope | PCS | $V_{BATT} = 3.5\ \text{V}$ $P_{IN} = 3\ \text{dBm}$ $P_{OUT} = 0\ \text{dBm}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 80 | — | dB/V |

¹ V_{RAMP} is calibrated to each PCL at $T_{CASE} = +25\text{ }^{\circ}\text{C}$, $V_{BATT} = 3.5\ \text{V}$, $P_{IN} = 3\ \text{dBm}$, $50\ \Omega$ load.

² Terminate all unused RF ports with $50\ \Omega$ loads

Table 8-1. SKY77589-21 Electrical Specifications

Unless otherwise specified: $T_{CASE} = -20\text{ }^{\circ}\text{C}$ to max. operating temperature (see Table 2); $RL = 50\ \Omega$; pulsed operation with pulse width $\leq 1154\ \mu\text{s}$; duty cycle $\leq 2:8$; $3.1\ \text{V} \leq V_{CC} \leq 4.3\ \text{V}$

| PCS1900 (Tx_HB) Mode ($f = 1850\ \text{MHz}$ to $1910\ \text{MHz}$, $0\ \text{dBm} \leq P_{IN} \leq 6\ \text{dBm}$) | | | | | | |
|--|----------------------------|--|---------|---------|---------|-------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Units |
| Frequency Range | f | — | 1850 | — | 1910 | MHz |
| Input Power | P_{IN} | — | 0 | — | 6 | dBm |
| Analog Power Control Voltage | V_{RAMP} | Minimum PCL to PRATED | — | — | 1.6 | V |
| Power Added Efficiency | PAE | $V_{BATT} = 3.5\ \text{V}$ $P_{OUT} = 31\ \text{dBm}$ $P_{IN} = 3\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 39 | — | % |
| Supply Current at Rated Power | $I_{BATT_31\ \text{dBm}}$ | $V_{BATT} = 3.5\ \text{V}$ $P_{IN} = 3\ \text{dBm}$ $P_{OUT} = 31\ \text{dBm}$ duty cycle 1:8 $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 0.92 | 0.97 | A |
| Harmonics | $2f_0$ to $6f_0$ | $BW = 3\ \text{MHz}$, $0\ \text{dBm} \leq P_{OUT} \leq 31\ \text{dBm}$ V_{RAMP} controlled ¹ | — | -40 | -33 | dBm |
| Output Power | P_{OUT_MAX} | $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | — | 32.0 | — | dBm |
| | $P_{OUT_MAX_EXTREME}$ | $V_{BATT} = 3.1\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ $P_{IN} = 0\ \text{dBm}$ | 29.0 | — | — | |
| Input VSWR | Γ_{IN} | $0\ \text{dBm}$ $P_{OUT} \leq 31\ \text{dBm}$ V_{RAMP} controlled ¹ | — | 1.5:1 | 2.5:1 | — |
| Forward Isolation ² | P_{OUT_RX} | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_LOW}$ $BS2 = V_{BS2_LOW}$ $TxEN = V_{TxEN_LOW}$ | — | -60 | -51 | dBm |
| | $P_{OUT_ENABLED_TX}$ | $P_{IN} = 6\ \text{dBm}$ $V_{RAMP} \leq 0.1\ \text{V}$ $BS1 = V_{BS1_HIGH}$ $BS2 = V_{BS2_HIGH}$ $TxEN = V_{TxEN_HIGH}$ | — | -40 | -15 | |

Table 8-2. SKY77589-21 Electrical Specifications

Unless otherwise specified: $T_{CASE} = -20\text{ }^{\circ}\text{C}$ to max. operating temperature (see Table 2); $RL = 50\ \Omega$; pulsed operation with pulse width $\leq 1154\ \mu\text{s}$; duty cycle $\leq 2:8$; $3.1\ \text{V} \leq V_{CC} \leq 4.3\ \text{V}$

| PCS1900 (Tx_HB) Mode ($f = 1850\ \text{MHz}$ to $1910\ \text{MHz}$, $0\ \text{dBm} \leq P_{IN} \leq 6\ \text{dBm}$) | | | | | | |
|--|---------------|--|--|---------|---------|-------|
| Parameter | Symbol | Test Condition | Minimum | Typical | Maximum | Units |
| Coupling of PCS Tx Output to Receive RF Output pad ² | CPCS_Tx-Rx_fo | $0\ \text{dBm} \leq P_{OUT} \leq 31\ \text{dBm}$ | — | — | 5 | dBm |
| Spurious | Spur | All combinations of the following parameters: VRAMP = controlled ¹ PIN = min. to max. $3.1\ \text{V} \leq V_{BATT} \leq 4.3\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ Load VSWR = 12:1, all phase angles | No parasitic oscillation $> -36\ \text{dBm}$ | | | |
| Load Mismatch | Load | All combinations of the following parameters: VRAMP = controlled ¹ PIN = min. to max. $3.1\ \text{V} \leq V_{BATT} \leq 4.3\ \text{V}$ $-20\text{ }^{\circ}\text{C} \leq T_{CASE} \leq +85\text{ }^{\circ}\text{C}$ Load VSWR = 20:1, all phase angles | No module damage or permanent degradation | | | |
| Rx Band Noise | RX_NOISE | At $f_0 + 20\ \text{MHz}$ (1930 MHz to 1990 MHz) RBW = 100 kHz $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{OUT} = 31\ \text{dBm}$ | — | — | -83 | dBm |
| | | 869 MHz to 894 MHz RBW = 100 kHz $V_{BATT} = 3.5\ \text{V}$ $T_{CASE} = +25\text{ }^{\circ}\text{C}$ $P_{OUT} = 31\ \text{dBm}$ | — | — | -87 | |
| Power Control Dynamic Range | PCDR | — | 35 | — | — | dB |
| Power Control Slope | PCS | $V_{BATT} = 3.5\ \text{V}$ PIN = 3 dBm P _{OUT} = 0 dBm $T_{CASE} = +25\text{ }^{\circ}\text{C}$ | — | 80 | — | dB/V |

¹ VRAMP is calibrated to each PCL at $T_{CASE} = +25\text{ }^{\circ}\text{C}$, $V_{BATT} = 3.5\ \text{V}$, $P_{IN} = 3\ \text{dBm}$, $50\ \Omega$ load.

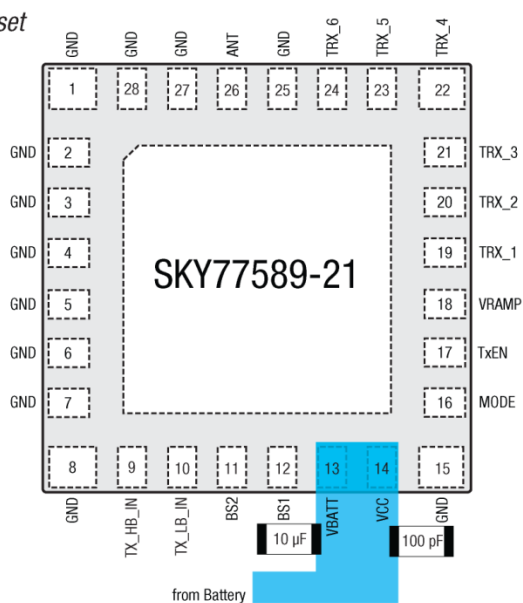
² Terminate all unused RF ports with $50\ \Omega$ loads

Table 9. 77589-21 Electrical Characteristics

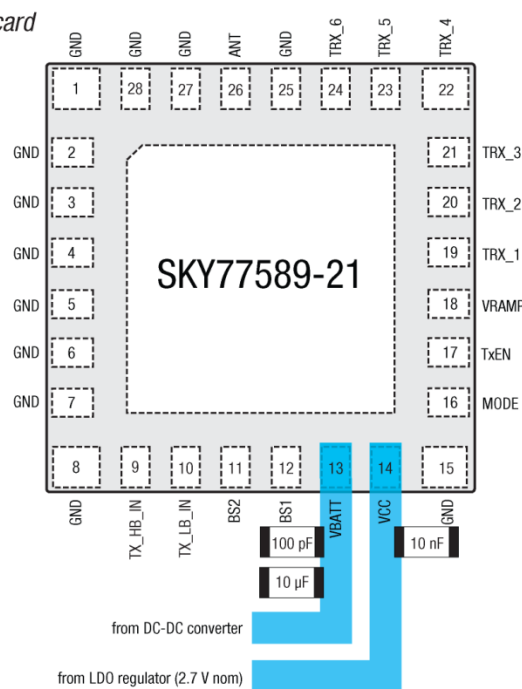
Unless otherwise specified: 50 Ω system; pulsed operation with pulse width 2308 μs; -20 °C ≤ T_{CASE} ≤ +85 °C; 2.5 V ≤ V_{CC} ≤ 4.3 V; Terminate all unused RF ports with 50 Ω during test.

| Ports TRx1 to TRx6 | | | | | | | |
|------------------------------|--------------------|---|---|---------|---------|------|----|
| Tx-Rx Mode | | | | | | | |
| Parameter | Symbol | Conditions | Minimum | Typical | Maximum | Unit | |
| Frequency Range | 3G_Tx/Rx | $f_{3G_Tx/Rx}$ | 824 | — | 2170 | MHz | |
| Insertion Loss | ANT – 3G_Tx/Rx | 3G_Tx/Rx | 824 MHz to 960 MHz T _{CASE} = +25°C | — | 0.60 | 0.95 | dB |
| | | | 1710 MHz to 1990 MHz T _{CASE} = +25°C | — | 0.70 | 0.95 | |
| | | | 2110 MHz to 2170 MHz T _{CASE} = +25°C | — | 1.00 | 1.20 | |
| Isolation | ADJACENT | Ports TRx1 through TRx6 to any other ADJACENT port (824 MHz to 960 MHz) | 25 | — | — | dB | |
| | | Ports TRx1 through TRx6 to any other ADJACENT port (1710 MHz to 1990 MHz) | 25 | — | — | | |
| | NON-ADJACENT | Ports TRx1 through TRx6 to any other NON-ADJACENT port (824 MHz to 960 MHz) | 30 | — | — | | |
| | | Ports TRx1 through TRx6 to any other NON-ADJACENT port (1710 MHz to 1990 MHz) | 30 | — | — | | |
| IMD2 | $f_{Rx} - f_{Tx}$ | Tx Output Power = 20 dBm Blocker Power = -15 dBm | — | — | -95 | dBm | |
| | $f_{Rx} + f_{Tx}$ | | — | — | -95 | | |
| IMD3 | $2f_{Tx} - f_{Rx}$ | Blocker frequency impedance is swept over all phase angles at the WCDMA port. (Minimum VSWR at blocker is 10:1 to model out-of-band duplexer impedance. | — | — | -97 | | |
| | $2f_{Rx} - f_{Tx}$ | | — | — | -97 | | |
| Leakage from Tx to TRx Ports | P_TRx | — | — | — | 5 | dBm | |

Handset



Datacard



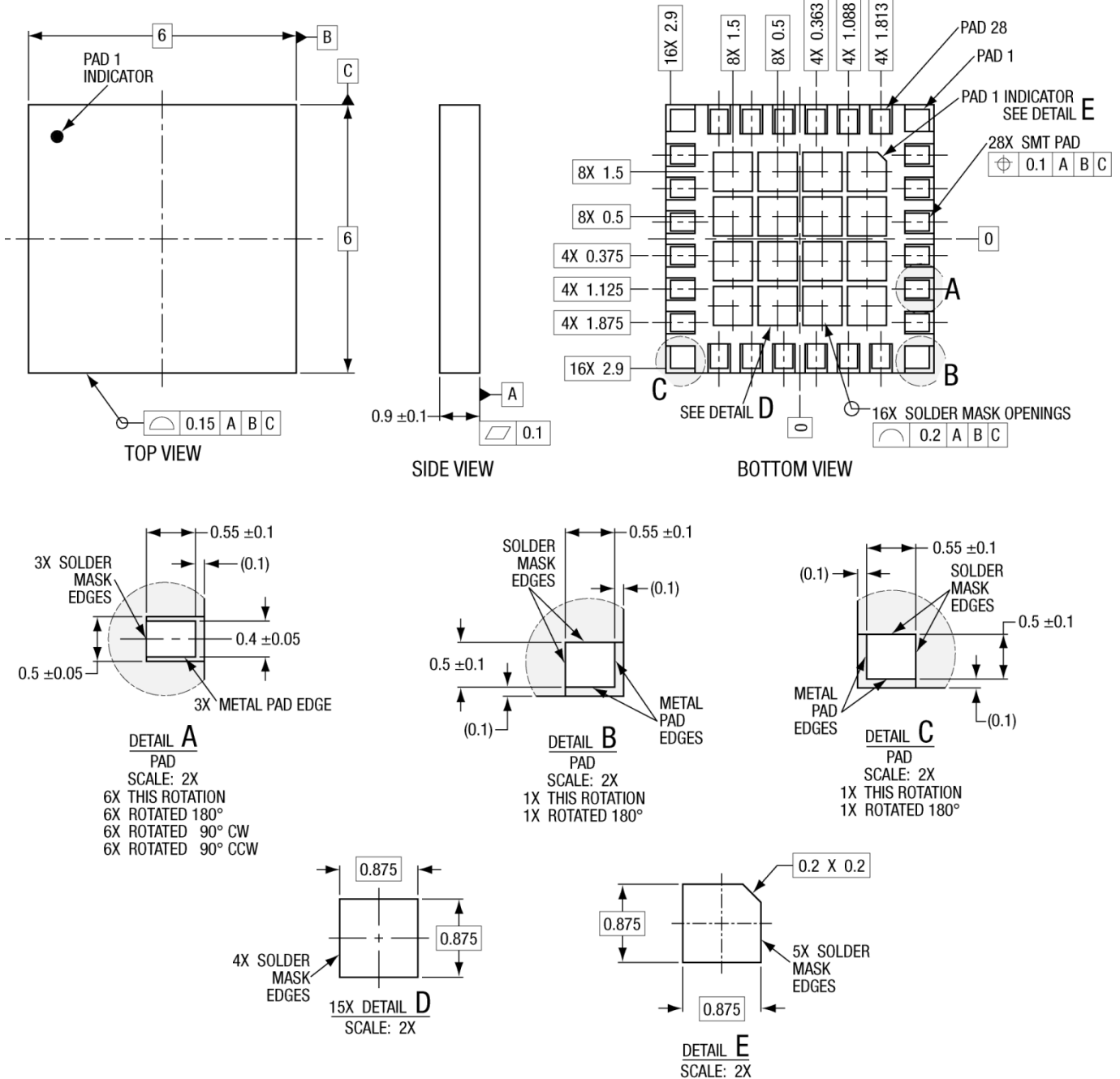
NOTE: Place capacitors as close to part as possible.

Figure 2. SKY77589-21 Application Schematic Diagram

Package Dimensions

Figure 3 is a mechanical diagram of the pad layout for the SKY77589-21, a 28-pad leadless dual-band Front-End Module. Figure 4 provides a recommended phone board layout footprint

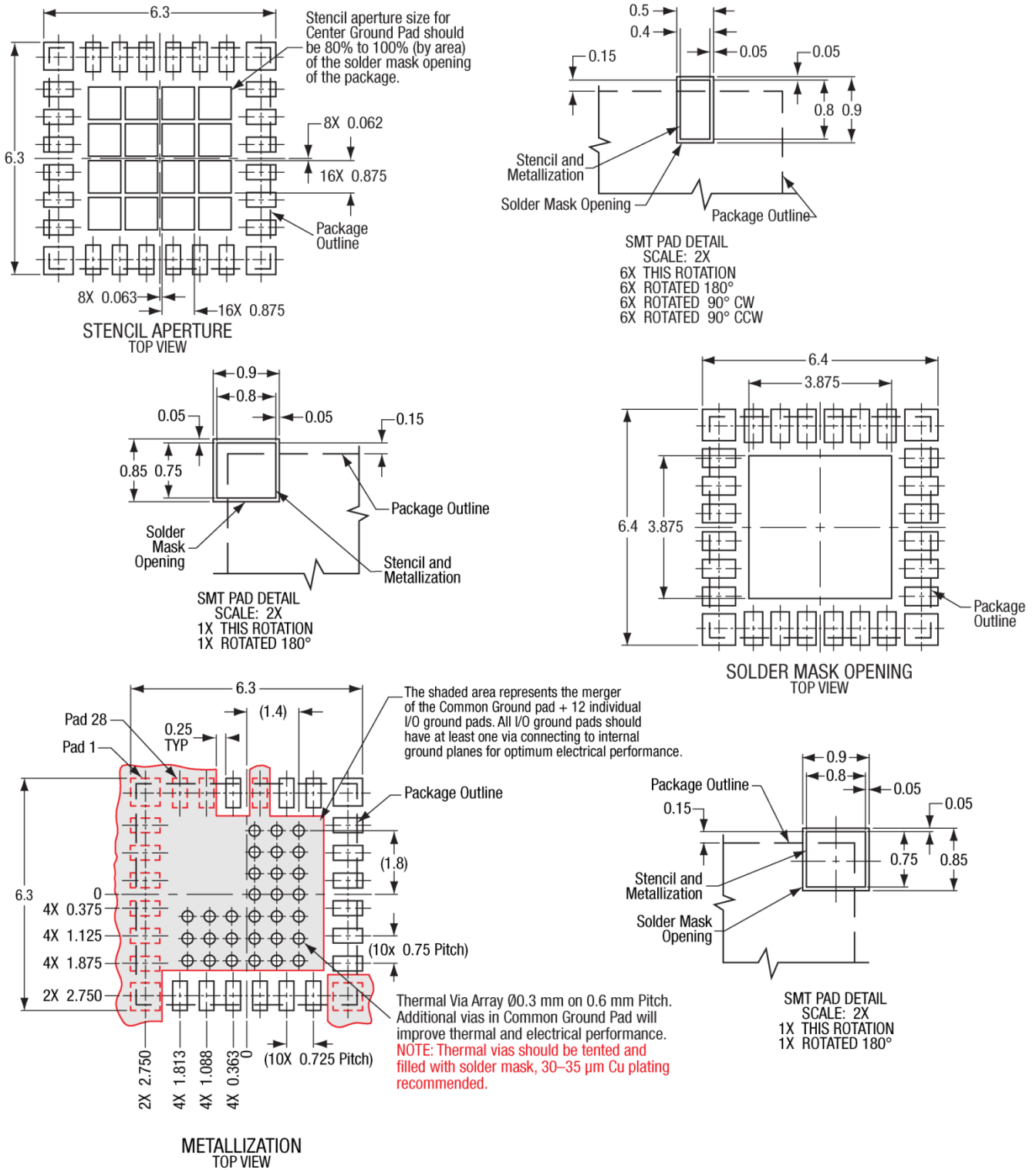
for the Front-End Module to help the designer attain optimum thermal conductivity, good grounding, and minimum RF discontinuity for the 50-ohm terminals.



- NOTES: Unless otherwise specified.
 1. Dimensioning and Tolerancing in accordance with ASME Y14.5M-1994.
 2. All dimensions are in millimeters.
 3. Pad definitions per details on drawing.

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Figure 3. Dimensional Drawing for 6 mm x 6 mm x 0.9 mm, 28-Pad Package – SKY77589-21 Specific (All Views)

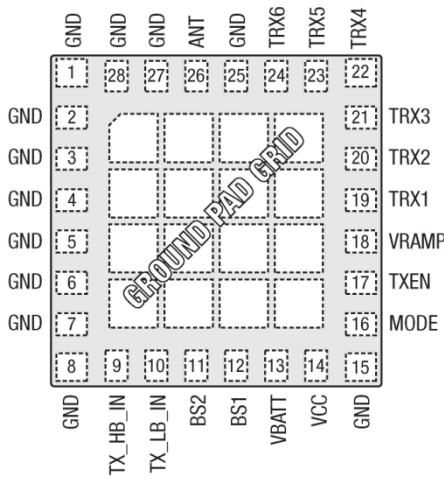


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Figure 4. Phone PCB Layout Footprint for 6 mm x 6 mm, 28-Pad Package with Grid-Bottom Solder Mask – SKY77589-21 Specific.

Package Description

Figure 5 illustrates the device pad configuration and the numbering convention which starts with pad 1 at the lower left,

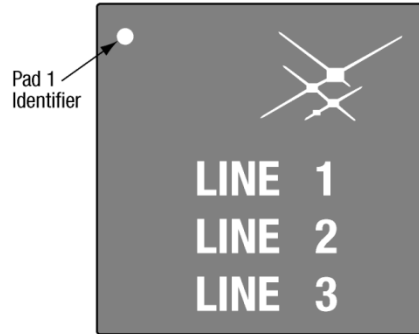


Pad layout as seen from Top View looking through package.

202694_005

Figure 5. SKY77589-21 Pad Configuration – 28-Pad Leadless (Top View)

as indicated and increments counter-clockwise around the package. Table 10 lists the pad names and the associated signal descriptions. Figure 6 interprets typical case markings.



NOTE: Lines 1, 2, 3 have a maximum of 12 characters
Line 1 = Part Number and Version
Line 2 = Lot Number
Line 3 = Year-Week-Country Code (MX)

202694_006

Figure 6. Typical Case Markings

Table 10. SKY77589-21 Pad Names and Signal Descriptions

| Pad ¹ | Name | Description |
|------------------|----------|------------------------------------|
| 9 | Tx_HB_IN | Input Tx signal 1710 MHz–1910 MHz |
| 10 | Tx_LB_IN | Input Tx signal 824 MHz–915 MHz |
| 11 | BS2 | Band Select |
| 12 | BS1 | Band Select |
| 13 | VBATT | Battery supply voltage |
| 14 | VCC | Switch supply voltage |
| 16 | MODE | 0 = GMSK |
| 17 | TxEN | Enable TxEN |
| 18 | VRAMP | Controls power in GMSK mode |
| 19 | TRx1 | Wideband TRx switch port |
| 20 | TRx2 | Wideband TRx switch port |
| 21 | TRx3 | Wideband TRx switch port |
| 22 | TRx4 | Wideband TRx switch port |
| 23 | TRx5 | Wideband TRx switch port |
| 24 | TRx6 | Wideband TRx switch port |
| 26 | ANT | PA output to Antenna |
| Ground Pad Grid | | Ground Pad Grid (device underside) |

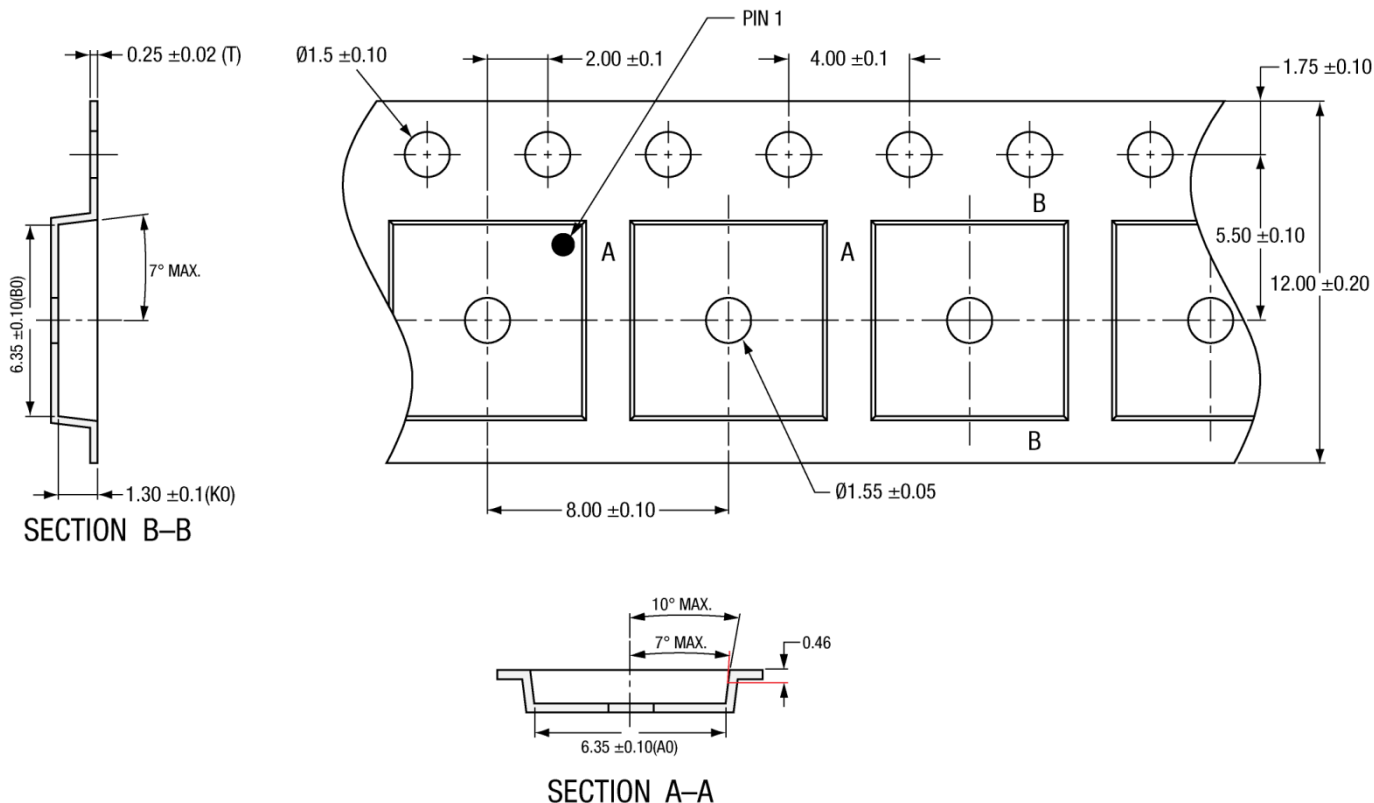
¹ Pads 1–8, 15, 25, 27, 28 are ground pads.

Package Handling Information

Because of its sensitivity to moisture absorption, this device package is baked and vacuum-packed prior to shipment. Instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY77589-21 is capable of withstanding an MSL3/260 °C solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is attached in a reflow oven, the temperature ramp rate should not exceed 3 °C per second; maximum temperature should not exceed 260 °C. If the part is manually attached, precaution should be taken to insure that the part is not subjected to temperatures exceeding 260 °C for more than 10 seconds. For details on attachment techniques, precautions, and handling procedures recommended by Skyworks, please refer to Skyworks Application Note: *PCB Design and SMT Assembly/Rework*, Document Number 101752. Additional information on standard SMT reflow profiles can also be found in the JEDEC *Joint Industry Standard J-STD-020*.

Production quantities of this product are shipped in the standard tape-and-reel format (Figure 7).



NOTES:

1. CARRIER TAPE IS BLACK CONDUCTIVE POLYCARBONATE OR POLYSTYRENE.
2. COVER TAPE IS TRANSPARENT AND CONDUCTIVE.
3. ESD-SURFACE RESISTIVITY IS $\leq 1 \times 10^{10}$ OHMS/SQUARE PER EIA, JEDEC TNR SPECIFICATION.
4. ALL DIMENSIONS ARE IN MILLIMETERS.

CARRIER TAPE: OVERMOLD MCM/RLGA 6 x 6 x 0.85 / 1.1 mm BODY SIZE -193H XXXXX_YYY

Figure 7. Dimensional Diagram for Carrier Tape Body Size 6 mm x 6 mm x 0.85 / 1.1 mm – MCM

Electrostatic Discharge (ESD) Sensitivity



Attention: Observe Precautions for Handling Electrostatic Sensitive Devices
Electrostatic Discharge (ESD) can damage this device, which must be protected from ESD at all times. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

To avoid ESD damage, both latent and visible, it is very important that the product assembly and test areas follow the ESD handling precautions listed below.

- Personnel Grounding
 - Wrist Straps
 - Conductive Smocks, Gloves and Finger Cots
 - Antistatic ID Badges
- Protective Workstation
 - Dissipative Table Top
 - Protective Test Equipment (Properly Grounded)
 - Grounded Tip Soldering Irons
 - Solder Conductive Suckers
 - Static Sensors
- Facility
 - Relative Humidity Control and Air Ionizers
 - Dissipative Floors (less than 1,000 MΩ to GND)
- Protective Packaging and Transportation
 - Bags and Pouches (Faraday Shield)
 - Protective Tote Boxes (Conductive Static Shielding)
 - Protective Trays
 - Grounded Carts
 - Protective Work Order Holders

Ordering Information

| Product Name | Order Number | Evaluation Board Part Number |
|--|--------------|------------------------------|
| SKY77589-21 Tx-Rx Quad-Band Front-End Module | SKY77589-21 | |

Revision History

| Revision | Date | Description |
|----------|-------------------|---|
| A | February 14, 2013 | Initial Release – Information |
| B | September 3, 2013 | Revise: Figure 2; Tables 5, 6 |
| C | May 12, 2016 | Revise: Table 1 (add Operating Temperature); update format. |

References

Skyworks Application Note: PCB Design and SMT Assembly/Rework, Document Number 101752

Standard SMT Reflow Profiles: JEDEC Standard J-STD-020

Electrostatic Discharge Sensitivity (ESD) Testing: JEDEC Standard, JESD22-A114 Human Body Model (HBM)

Electrostatic Discharge Sensitivity (ESD) Testing: JEDEC Standard, JESD22-C101 Charged Device Model (CDM).

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